



Microelectromechanical Systems (MEMSs): Design, Fabrication, Integration, and Applications

Guest Editors:

Dr. Jiahao Zhao

Department of Precision
Instrument, Tsinghua University,
Beijing 100084, China

Dr. Xiaoguang Zhao

Department of Precision
Instrument, Tsinghua University,
Beijing 100084, China

Deadline for manuscript
submissions:

closed (15 May 2024)

Message from the Guest Editors

MEMSs play a pivotal role in enabling miniaturized high-performance sensors and actuators, and are instrumental in driving forward the ongoing intelligence revolution, where interconnected and intelligent systems and IoT applications rely on MEMS devices for data acquisition, processing, and control. Recent developments in the design methodology, fabrication, and integration techniques advance MEMSs toward intelligent microsystems.

This Special Issue will be focused on the design, fabrication, and integration technology for enabling novel MEMS devices and applications in various electronic systems. In this Special Issue, original research articles and reviews are welcome. Research areas may include (but are not limited to) the following:

- The system-level modelling of MEMSs;
- The multiphysics simulation of MEMSs;
- Advanced materials in MEMSs;
- Novel fabrication and integration techniques for MEMSs;
- The design and implementation of electronic circuits for MEMSs;
- Artificial intelligence and MEMSs;
- Novel applications of MEMSs.





an Open Access Journal by MDPI

Editor-in-Chief

Prof. Dr. Flavio Canavero

Department of Electronics and
Telecommunications,
Politecnico di Torino, 10129
Torino, Italy

Message from the Editor-in-Chief

Electronics is a multidisciplinary journal designed to appeal to a diverse audience of research scientists, practitioners, and developers in academia and industry. The journal is devoted to fast publication of latest technological breakthroughs, cutting-edge developments, and timely reviews of current and emerging technologies related to the broad field of electronics. Experimental and theoretical results are published as regular peer-reviewed articles or as articles within Special Issues guest-edited by leading experts in selected topics of interest.

Author Benefits

Open Access: free for readers, with [article processing charges \(APC\)](#) paid by authors or their institutions.

High Visibility: indexed within [Scopus](#), [SCIE \(Web of Science\)](#), [CAPus / SciFinder](#), [Inspec](#), and [other databases](#).

Journal Rank: JCR - Q2 (*Electrical and Electronic Engineering*) CiteScore - Q2 (*Electrical and Electronic Engineering*)

Contact Us

Electronics Editorial Office
MDPI, St. Alban-Anlage 66
4052 Basel, Switzerland

Tel: +41 61 683 77 34
www.mdpi.com

mdpi.com/journal/electronics
electronics@mdpi.com
[X@electronicsMDPI](https://twitter.com/electronicsMDPI)